




SPECIFICATION SHEET NO.	S0226- CR1206FB820KS1	
ORIGINAL MFG/PART NO.	Aillen Capacitors/CR06FB820K	
NEXTGEN PART CODE	CR1206FB820KS1	Indicate This Code For RFQ /Order
DATE	Feb. 26, 2025	
REVISION	A3	Updated With Most Recent Data
DESCRIPTION AND MAIN PARAMETRICS	<p>Thick Film Chip Resistors, 1206 (3216 Metric), CR06 Series, Dimension L3.10*W1.60*H0.60mm, 2 Terminations, Tolerance: $\pm 1.0\%$, Resistance Range 820Kohm, Dissipation Max. 1/4W @ 70°C, Temperature Coefficient Rate (TCR) Max. $\pm 100\text{ppm}/^\circ\text{C}$ Operating Temp. Range -55°C ~+155°C Package in Tape/Reel, 5,000pcs/Reel REACH/RoHS/RoHS III Compliant and HF</p>	
CUSTOMER		
CUSTOMER PART NUMBER		
CROSS REF. PART NUMBER		
MEMO		

VENDOR APPROVE		
Issued/Checked/Approved	  	
Date: Feb. 26, 2025		

CUSTOMER APPROVE
DATE:

DESCRIPTION

The resistors are constructed in a high grade ceramic body (aluminum oxide).

Internal metal electrodes are added at each end and connected by a resistive

paste that is applied to the top surface of the substrate. The composition of the paste

is adjusted to give the approximate resistance required and the value is trimmed to

within tolerance by laser cutting of this resistive layer. The resistive layer is covered

with a protective coat. Finally, the two external end terminations are added. For ease

of soldering the outer layer of these end terminations is a Tin (lead free) alloy.

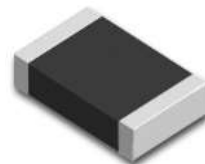


Image shown is a representation only. Exact specifications should be obtained from the product dimension.

MAIN FEATURE

- High Reliability And Stability
- Reduced Size Of Final Equipment
- Lower Assembly Costs
- Higher Component And Equipment Reliability
- REACH/RoHS/RoHS III Compliant And Halogen Free Products



APPLICATION

- Consumer Electrical Equipment
- EDP, Computer Application
- Telecom Application

ELECTRICAL CHARACTERISTICS

- See Page 5 ~page 6
- All Products Parameters are Subject To NextGen Components' Final Confirmation.

HOW TO ORDER

- Please Follow Up Part Code Guide And Indicate Part Code CR1206FB820KS1 For RFQ/Order.

PART CODE GUIDE

RFQ
[Request For Quotation](#)

CODE	NAME	KEY SPECIFICATION OPTION
CR	Product Index	Thick Film Chip Resistors
1206	Case Size	1206: 1206 (3216 Metric), L3.10*W1.60*H0.60mm
F	Resistance Tolerance	B: $\pm 0.1\%$; D: $\pm 0.5\%$; F: $\pm 1\%$; J: $\pm 5\%$; P: Jumper
B	Quantity Per Reel	A: 4Kpcs/7"Reel B: 5kpcs/7"Reel Z: 3kpcs/7"Reel
820K	Resistance Value	1R2: 1.2ohm; 75R: 75ohm; 100R: 100ohm; 1K: 1Kohm; 1K37: 1.37Kohm; 4K12: 4.12Kohm; 100K: 100Kohm; 820K: 820Kohm 1M: 1.0Mohm; 1M2: 1.2Mohm
S1	Suffix	Blank: N/A XX: Internal Control Code, Letter A~Z, a~z or digits (0~9) for Special/Custom Parameters

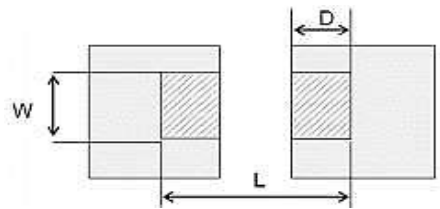
DIMENSION (Unit: mm)

Case Size:1206 (3216 metric)
L3.10*W1.60*H0.60mm



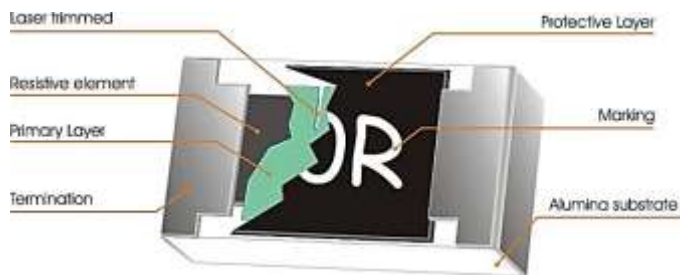
ITEM	DIMENSION
L	3.10±0.10
W	1.60±0.10
T	0.60±0.15
T b	0.45±0.20
T t	0.50±0.20

Recommended
Solder Pad



ITEM	DIMENSION
W	2.00~2.40
L	4.40~5.00
D	1.20~1.80

Construction For
Reference



TEST CONDITIONS - FOR JUMPER (0 ohm)

ITEM	UNIT	SYMBOL	CHARACTERISTIC	CONDITION
Power Rating	W		1/4	@ 70°C
Max. Resistance	mRΩ		50	
Rated Current	A		2.0	
Peak Current	A		5.0	

GENERAL CONDITIONS - FOR DIFFERENT PART CODE

ITEM	UNIT	SYMBOL	CHARACTERISTIC	CONDITION
Operating Temperature Range	°C		-55 ~+155	
Storage Temperature Range	°C		5~+40	

Note

- 1) This is the maximum voltage that may be continuously supplied to the resistor element, see “IEC publication 60115-8”
- 2) Max. Operation Voltage : So called RCWV (Rated Continuous Working Voltage) is determined by

$$RCWV = \sqrt{\text{Rated Power} \times \text{Resistance Value}}$$
or Max. RCWV listed above, whichever is lower.
- 3) Test condition for jumper (0 Ω)

ELECTRICAL CHARACTERISTICS - Ta = 25°C, FOR DIFFERENT PART CODE

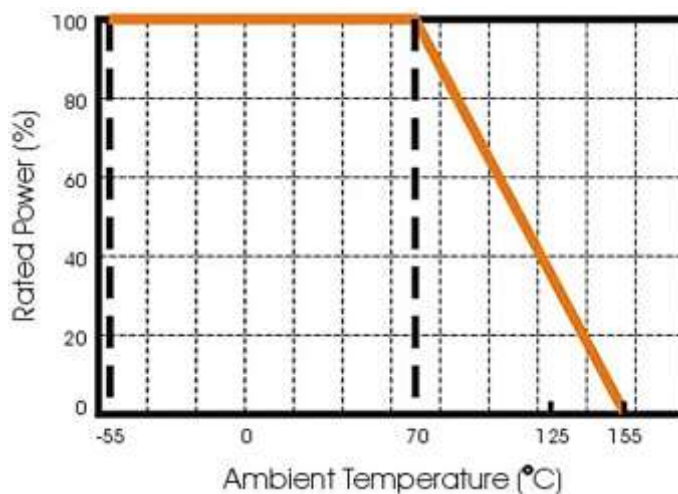
NextGen Part Code	Original Part Number	Resistance Tolerance	Resistance Range	Temp. Coefficient Rate (TRC)	Max. Dissipation @Tamb 70°C	Max. Operation Voltage (DC or RMS)	Max. Overload Voltage (DC or RMS)
		%	Ω	ppm/°C	W	V	V
CR1206PB0RS001	CR06PB0R	Jumper	0	-200~+400	1/4	200	400
CR1206JB6R8S01	CR06JB6R8	±5.0	6.8	-200~+400	1/4	200	400
CR1206JB11RS01	CR06JB11R	±5.0	11	±100	1/4	200	400
CR1206JB12RS01	CR06JB12R	±5.0	12	±100	1/4	200	400
CR1206JB330RS1	CR06JB330R	±5.0	330	±100	1/4	200	400
CR1206FB634RS1	CR06FB634R	±1.0	634	±100	1/4	200	400
CR1206FB1K37S1	CR06FB1K37	±1.0	1.37K	±100	1/4	200	400
CR1206FB2KS001	CR06FB2K	±1.0	2K	±100	1/4	200	400
CR1206FB2K49S1	CR06FB2K49	±1.0	2.49K	±100	1/4	200	400
CR1206FB3K9S01	CR06FB3K9	±1.0	3.9K	±100	1/4	200	400
CR1206FB4K12S1	CR06FB4K12	±1.0	4.12K	±100	1/4	200	400
CR1206JB240KS1	CR06JB240K	±5.0	240K	±100	1/4	200	400
CR1206FB820KS1	CR06FB820K	±1.0	820K	±100	1/4	200	400
CR1206FB1M5S01	CR06FB1M5	±1.0	1.5M	±100	1/4	200	400
CR1206FB2MS001	CR06FB2M	±1.0	2M	±100	1/4	200	400

PRODUCT CHARACTERIZATION

Standard values of nominal resistance are taken from the E24 & E96 series for resistors with a tolerance Of $\pm 0.1\%$, $\pm 0.5\%$, $\pm 1\%$ & $\pm 5\%$, The values of the E24/E96 series are in accordance with “IEC publication 60063”

DERATING

The power that the resistor can dissipate depends on the operating temperature; see the figure below:



Maximum dissipation in percentage of rated power as a function of the ambient temperature for CR06 ,CR05, CR03, CR02

MOUNTING

Due to their rectangular shapes and small tolerances, Surface Mountable Resistors are suitable for handling by automatic placement systems. Chip placement can be on ceramic substrates and printed-circuit boards (PCBs). Electrical connection to the circuit is by individual soldering condition. The end terminations guarantee a reliable contact.

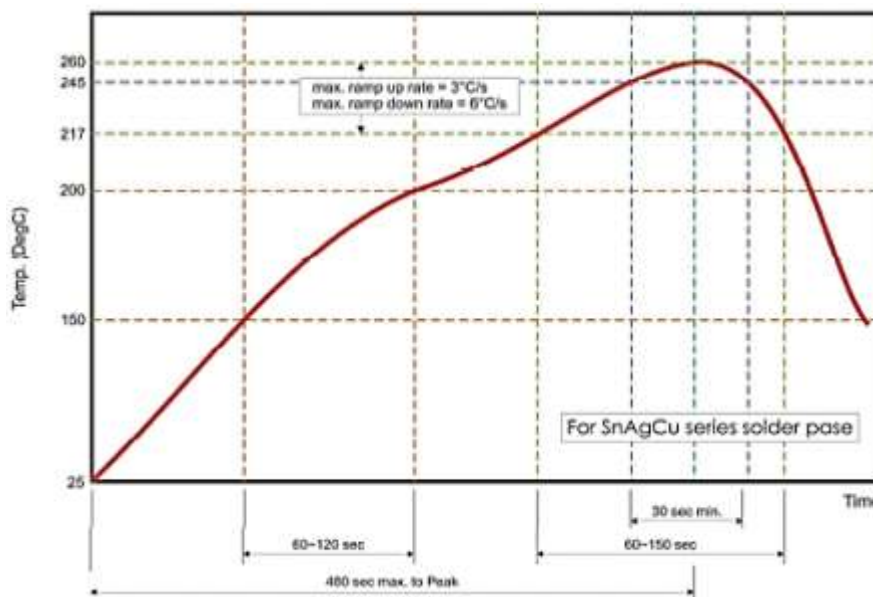
STORAGE AND HANDLING CONDITIONS

- 1) Products are recommended to be used up within two years since operation date as ensured shelf life. Check solderability in case shelf life extension is needed.
- 2) To store products with following condition: Temperature : 5 to 40°C Humidity: 20 to 70% relative humidity
- 3) Don't store products in a corrosive environment such as sulfide, chloride gas, or acid. It may cause oxidization of electrode, which easily be resulted in poor soldering b.To store products on the shelf and avoid exposure to moisture. Don't expose products to excessive shock, vibration, direct sunlight and so on.

2/26/2025

REFLOW SOLDERING CONDITION

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260 °C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs). Surface Mount Resistors are tested for solderability at 235 °C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in below.



Infrared soldering profile for Chip Resistors

TEST AND REQUIREMENTS

Essentially all tests are carried out according to the schedule of IEC publication 115-8, category LCT/UCT/56 (rated temperature range: Lower Category Temperature, Upper Category Temperature; damp heat, long term, 56 days). The testing also meets the requirements specified by EIA, EIAJ and JIS. The tests are carried out in accordance with IEC publication 68, "Recommended basic climatic and mechanical robustness testing procedure for electronic components" and under standard atmospheric conditions according to IEC 60068-1, subclause 5.3. Unless otherwise specified, the following value supplied

Temperature: 15 °C to 35 °C ; Relative humidity: 45% to 75%.

Air pressure: 86kPa to 106 kPa (860 mbar to 1060 mbar).

All soldering tests are performed with mildly activated flux

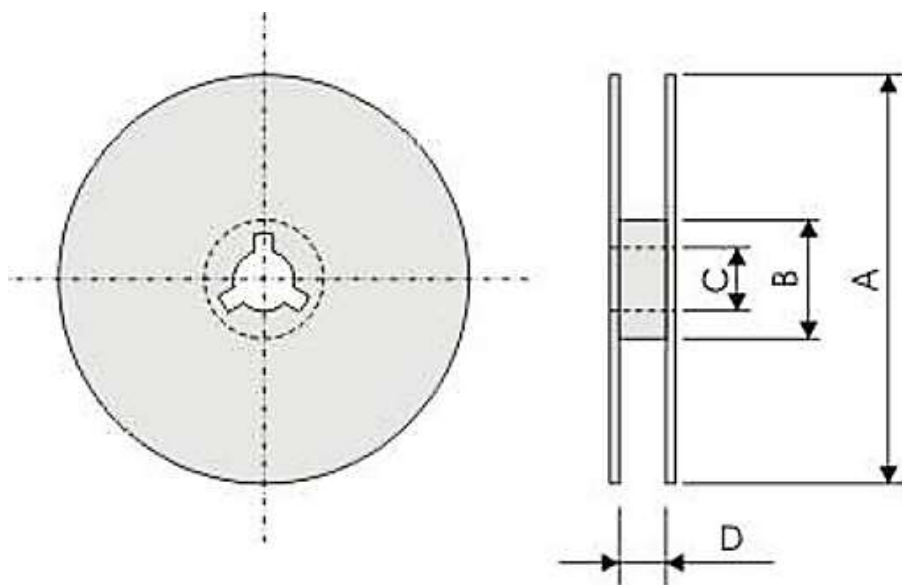
TEST AND REQUIREMENT (JIS C 5201-1 : 1998)

TEST	PROCEDURE / TEST METHOD	REQUIREMENT	
		Resistor	Ω
Electrical Characteristics JISC5201-1: 1998 Clause 4.8	- DC resistance values measurement - Temperature Coefficient of Resistance (T.C.R) Natural resistance change per change in degree centigrade. $\frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \text{ (ppm/}^\circ\text{C)}$ t1 : 20°C+5°C-1°C; t2 : -55°C or +155°C R1 : Resistance at reference temperature (20°C+5°C/- 1°C) R2: Resistance at test temperature (-55°C or +155°C)	Within the specified tolerance Refer to “QUICK REFERENCE DATA”	<50mΩ
Resistance To Soldering Heat(R.S.H) JISC5201-1:1998 Clause 4.18	Un-mounted chips completely immersed for 10±1 second in a SAC solder bath at 260°C±5°C	±5%: ΔR/R max. ±(1%+0.05Ω); ±1%: ΔR/R max. ±(0.5%+0.05Ω) no visible damage	<50mΩ
Solderability JISC5201-1: 1998 Clause 4.17	Un-mounted chips completely immersed for 2±0.5 second in a SAC solder bath at 235°C±5°C	95% coverage min., good tinning and no visible damage	
Temperature cycling JISC5201-1: 1998 Clause 4.19	30 minutes at -55°C±3°C, 2~3 minutes at 20°C+5°C-1°C, 30 minutes at +125°C±3°C, 2~3 minutes at 20°C+5°C1°C, total 5 continuous cycles	±5%: ΔR/R max. ±(1%+0.05Ω); ±1%: ΔR/R max. ±(0.5%+0.05Ω) no visible damage	<50mΩ
High Temperature Exposure MIL-STD-202 method 108	1000+48/-0 hours; without load in a temperature chamber controlled 155 ± 3 °C	±5%: ΔR/R max. ±(2%+0.1Ω); ±1%: ΔR/R max. ±(1%+0.1Ω) no visible damage	<50mΩ

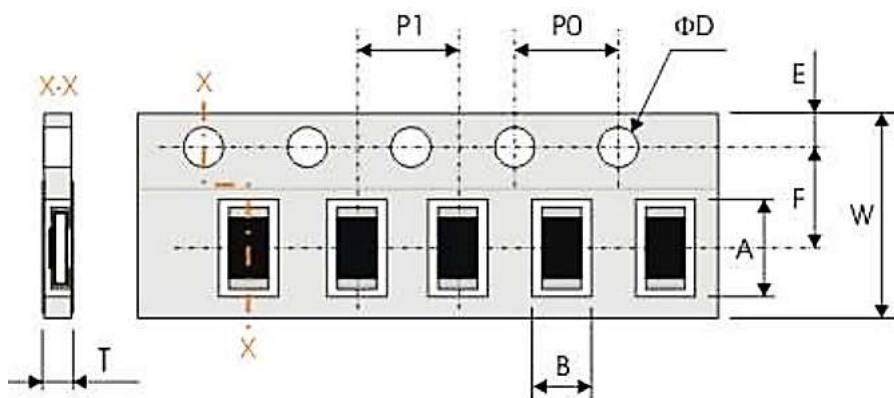
TEST AND REQUIREMENT (JIS C 5201-1 : 1998)

TEST	PROCEDURE / TEST METHOD	REQUIREMENT	
		Resistor	0Ω
Bending strength JISC5201-1: 1998 Clause 4.33	Resistors mounted on a 90mm glass epoxy resin PCB(FR4), bending once 3mm for 10sec, 5mm for CR02	±5%: $\Delta R/R$ max. ±(1%+0.05Ω); ±1%: $\Delta R/R$ max. ±(1%+0.05Ω) no visible damage	<50mΩ
Adhesion JISC5201-1: 1998 Clause 4.32	Pressurizing force: 5N, Test time: 10±1sec	No remarkable damage or removal of the terminations	
Short Time Overload (STOL) JISC5201-1: 1998 Clause 4.13	2.5 times RCWV or max. overload voltage, for 5seconds	±5%: $\Delta R/R$ max. ±(2%+0.05Ω); ±1%: $\Delta R/R$ max. ±(1%+0.05Ω) no visible damage	<50mΩ
Load life in Humidity JISC5201-1: 1998 Clause 4.24	1000 +48/-0 hours, loaded with RCWV or Vmax in humidity chamber controller at 40 °C ± 2 °C and 90~95% relative humidity, 1.5hours on and 0.5 hours off	±5%: $\Delta R/R$ max. ±(2%+0.1Ω); ±1%: $\Delta R/R$ max. ±(1%+0.1Ω) no visible damage	<50mΩ
Load life (endurance) JISC5201-1: 1998 Clause 4.25	1000 +48/-0 hours, loaded with RCWV or Vmax in chamber controller 70±2°C, 1.5 hours on and 0.5 Hours off	±5%: $\Delta R/R$ max. ±(3%+0.1Ω); ±1%: $\Delta R/R$ max. ±(1%+0.1Ω) no visible damage	<50mΩ
Insulation Resistance JISC5201-1: 1998 Clause 4.6	Apply the maximum overload voltage (DC) for 1minute	R ≥ 10GΩ	
Dielectric Withstand Voltage JISC5201-1: 1998 Clause 4.7	Apply the maximum overload voltage (AC) for 1 minute	No breakdown or flashover	

REEL DIMENSION (Unit: mm)



CODE	DIMENSION 7" Reel	DIMENSION 10" Reel	DIMENSION 13" Reel
A	$\varnothing 178.0 \pm 2.0$	$\varnothing 254.0 \pm 2.0$	$\varnothing 330.0 \pm 2.0$
B	$\varnothing 60.0 \pm 1.0$	$\varnothing 100 \pm 1.0$	$\varnothing 100 \pm 1.0$
C	13.0 ± 0.20	13.0 ± 0.20	13.0 ± 0.20
D	9.0 ± 0.50	9.0 ± 0.50	9.0 ± 0.50

TAPE DIMENSION (Unit: mm)


CODE	DIMENSION
A	3.60±0.20
B	2.00±0.20
W	8.00±0.30
F	3.50±0.20
E	1.75±0.10
P 1	4.00±0.10
P0	4.00±0.10
ΦD	1.50+0.10/-0.0
T	1.0 Max.

TAPING QUANTITY

TAPE	PAPER TAPE						EMBOSSSED TAPE	BULK CASSETTE
	4 mm Pitch			2 mm Pitch			4 mm Pitch	
Reel Size	7"	10"	13"	7"	10"	13"	7"	
CR06	5000	10000	20000				-	5000

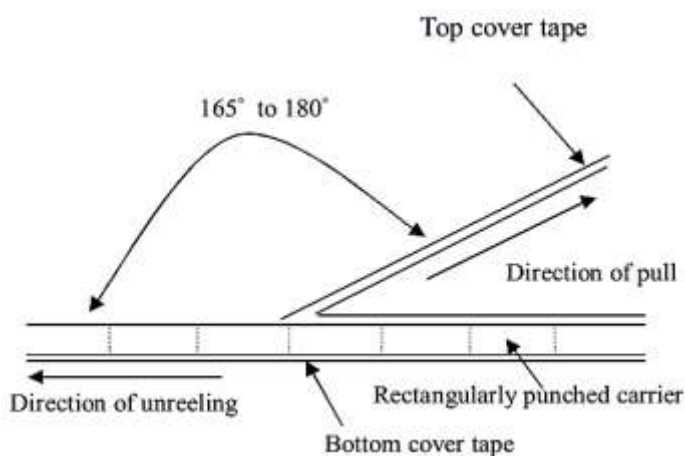
PERFORMANCE OF TAPING

Strength of Carrier Tape and Top Cover Tape

Carrier Tape: When a tensile force 1.02kgf is applied in the direction of unreeling the tape, the tape shall withstand this force. Top cover Tape: When a tensile force 1.02kgf is applied to the tape, the tape shall withstand this force.

Peel Force of Top Cover Tape

Unless otherwise specified, the peel force of top cover tape shall be 10.2 to 71.4 g f when the top cover tape is pulled at a speed of 300mm/min with the angle between the taped during peel and the direction of unreeling maintained at 165 to 180° as illustrated in Fig.



CAUTION

- Don't apply excess mechanical stress to the component and terminals at soldering. Do not use this product with bend.
- Do not clean or wash the component for it is not hermetically sealed.
- Do not use strong acidity flux, more than 0.2wt% chlorine content, in flow soldering.
- Don't be close to fire.
- This specification mentions the quality of the component as a single unit. Please insure the component is thoroughly evaluated in your application circuit
- Expire date (Shelf life) of the products is 12 months after delivery under the conditions of a sealed and an unopened package. Please use the products within 12 months after delivery. If you store the products for a long time (more than 12 months), use carefully because the products may be degraded in the solder-ability or rusty. Please confirm solder-ability and characteristics for the products regularly.
- Exposure components under soldering condition that is exceeding our recommendation will increase the failure dangerous.
- Please contact us before using the product as automobile electronic component.
- Please return one of these specifications after your signature of acceptance.
- When something gets doubtful with this specifications, we shall jointly work to get an agreement.
- For questions on technology, prices and delivery, please contact our sales offices or e-mail:

sales@NextGenComponent.com .

IMPORTANT NOTES AND DISCLAIMER

1. **ROHS COMPLIANCE:** The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU RoHS Directive (EU) 2015/863 EC (RoHS3). RoHS Test Report for this product can be obtained at Download Center.
2. **REACH COMPLIANCE:** REACH substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, REACH Test Report for this product can be obtained at Download Center.
3. All Product parametric performance is indicated in the Electrical Characteristics for the listed herein test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
4. NextGen Component, Inc (*NextGen*) reserves the right to make changes to this document and its products and specifications at any time without notice. Customers should obtain and confirm the latest product information and specifications before final design, purchase or use.
5. *NextGen* makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does *NextGen* assume any liability for application assistance or customer product design.
6. *NextGen* does not warrant or accept any liability with products which are purchased or used for any unintended or unauthorized application. No license is granted by implication or otherwise under any intellectual property rights of NextGen.
7. *NextGen* products are not authorized for use as critical components in life support devices or systems without express written approval by *NextGen*.
8. *NextGen* requires that customers first obtain an RMA (Returned Merchandise Authorization) number prior to returning any products. Returns must be made within 30 days of the date of invoice, be in the original packaging, unused and like-new condition. At the time of quoting or purchasing, a product may say that it is Non-Cancelable/ Non-Returnable (NCNR). These products are not returnable and not refundable.